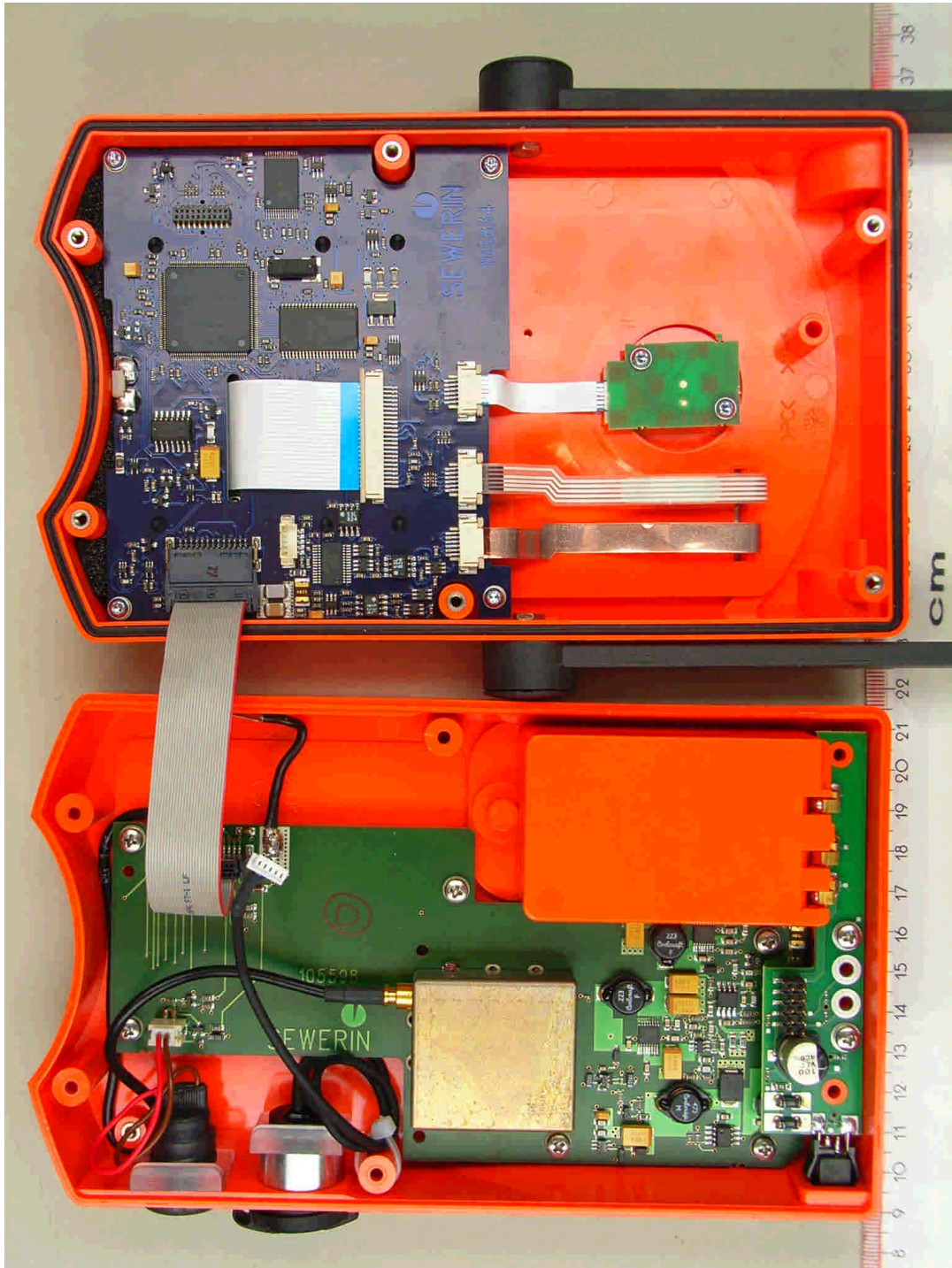


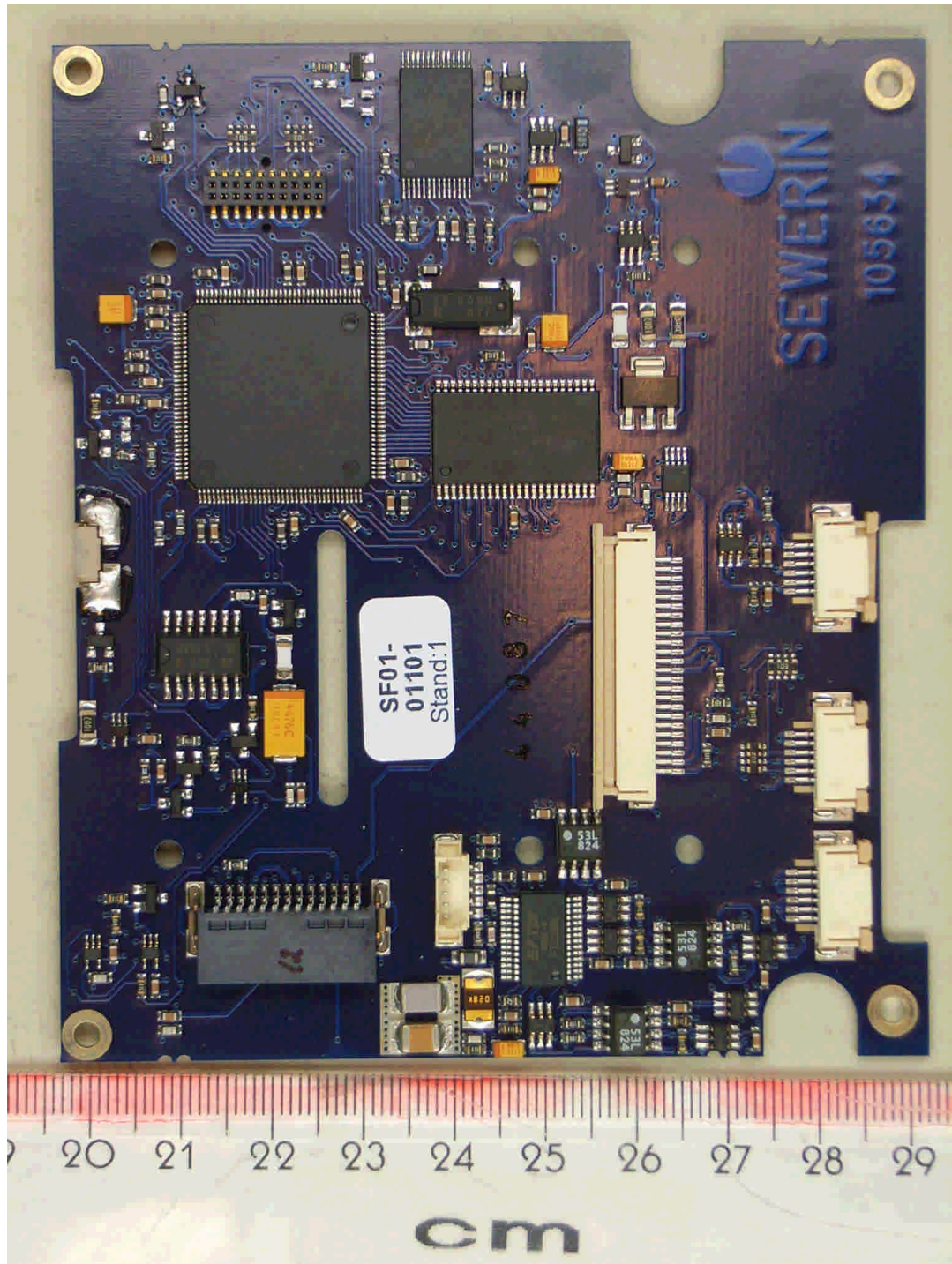
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_e.jpg

SePem 01 Master, internal view

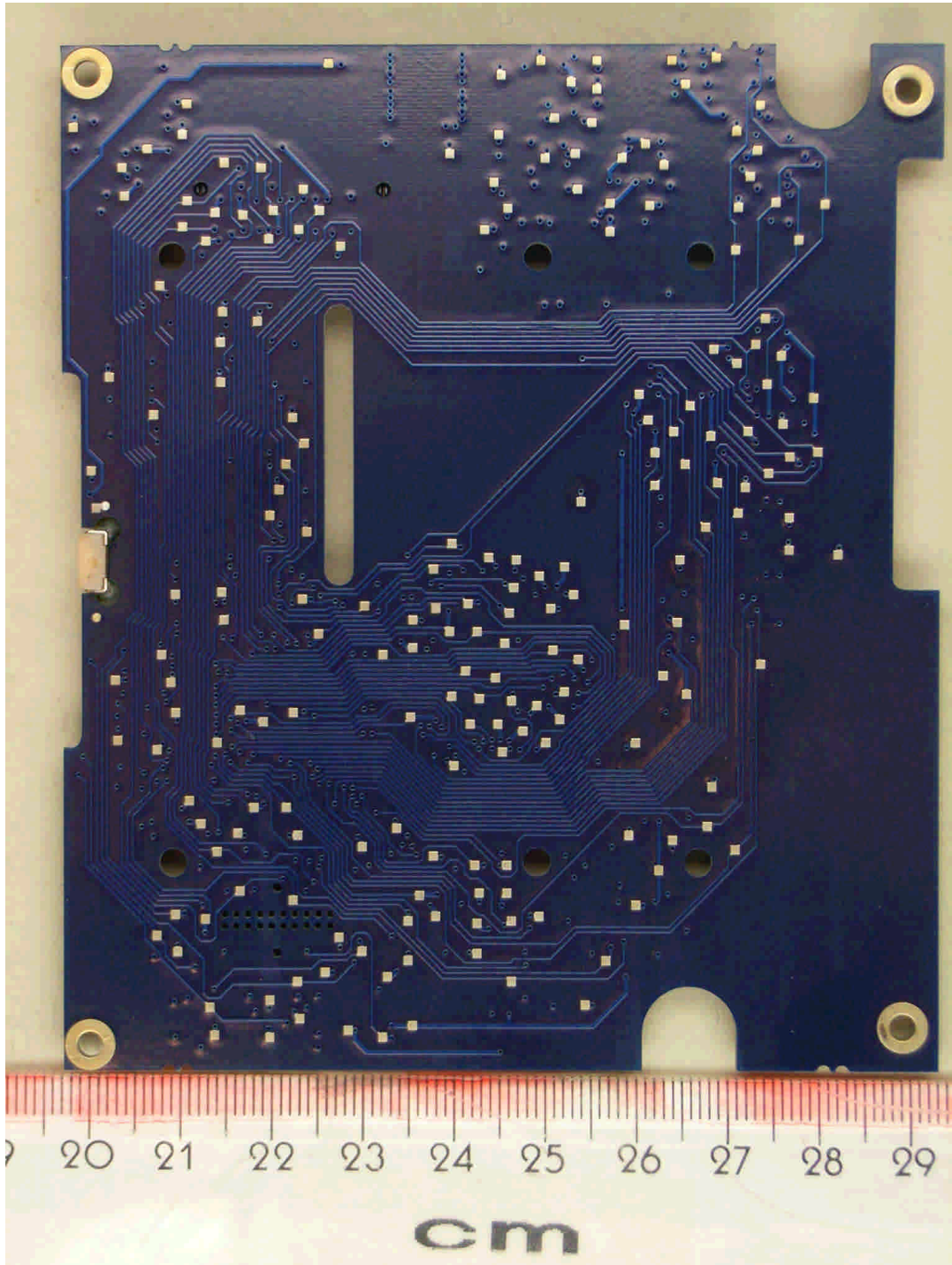
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_f.jpg

SePem 01 Master, controller PCB, top view

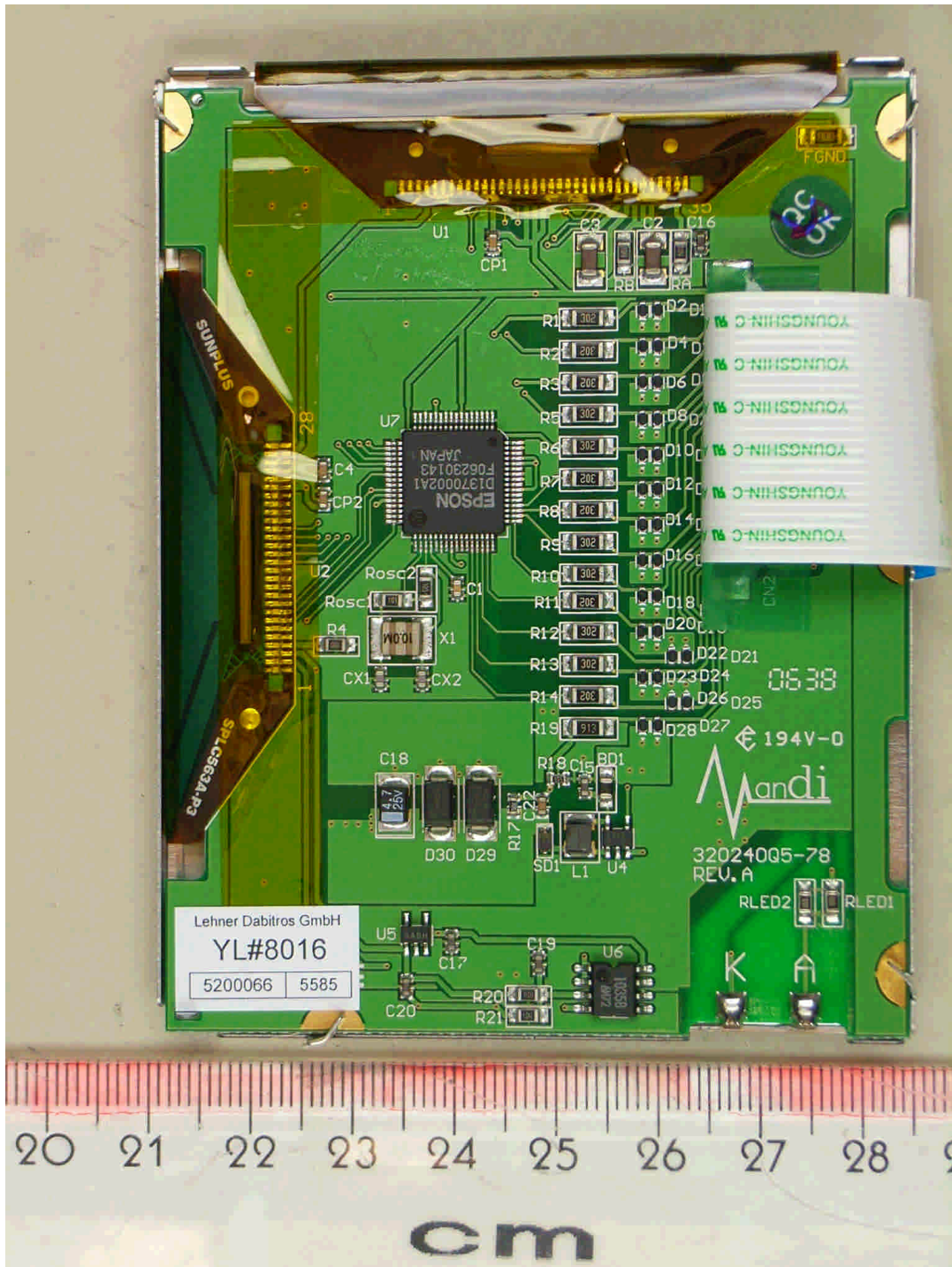
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_g.jpg

SePem 01 Master, controller PCB, bottom view

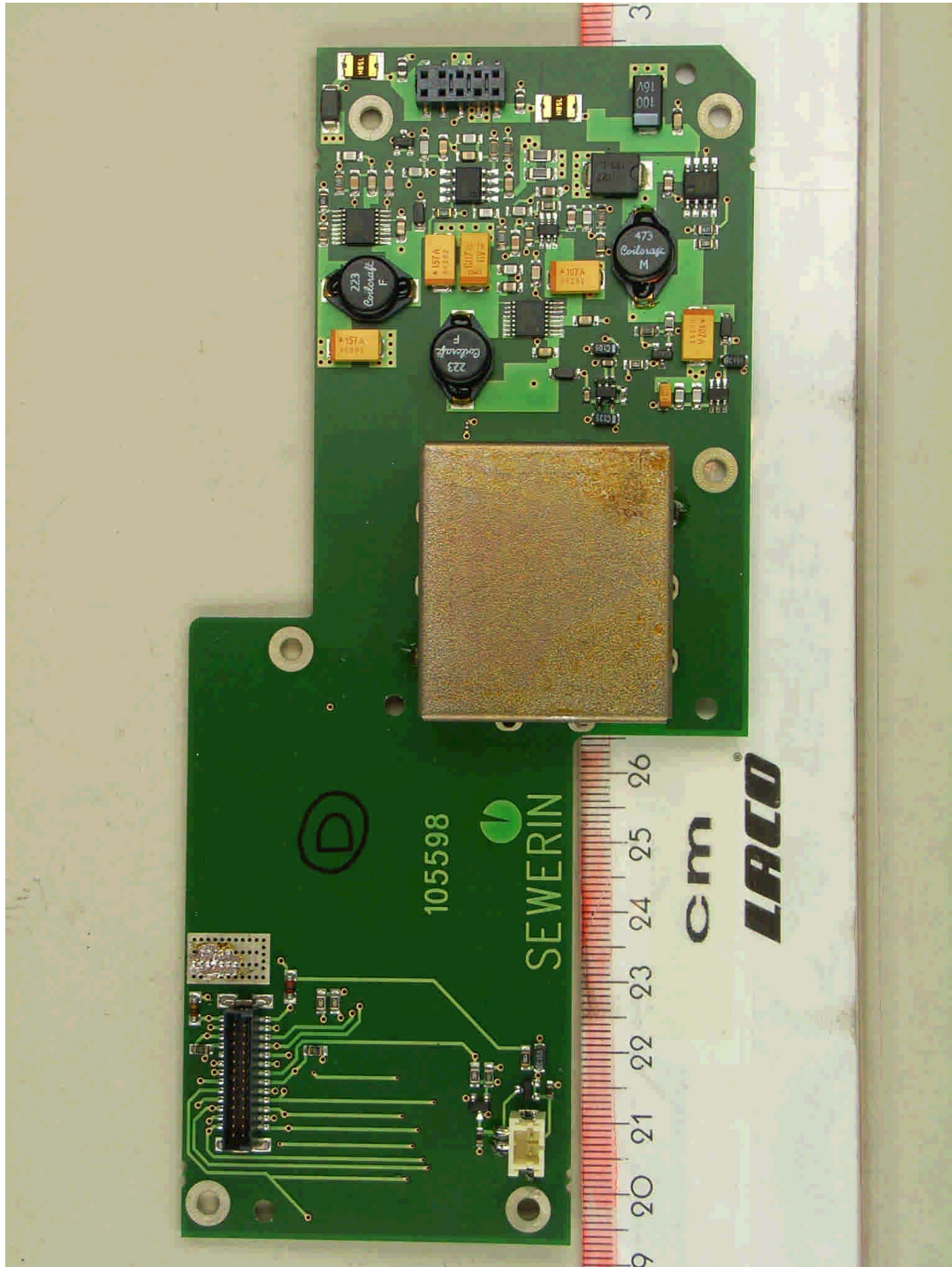
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_h.jpg

SePem 01 Master, display PCB, top view

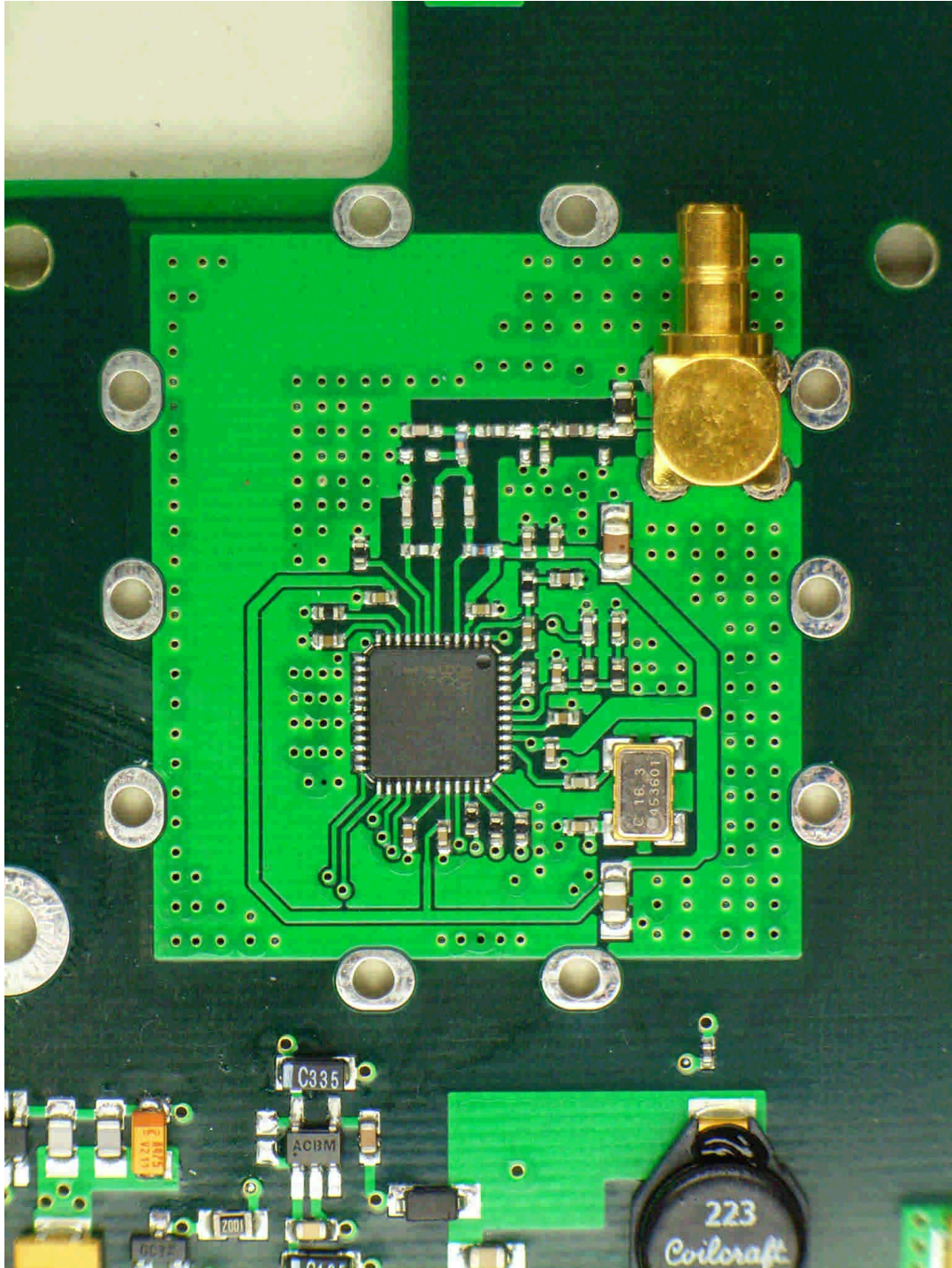
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_n.jpg

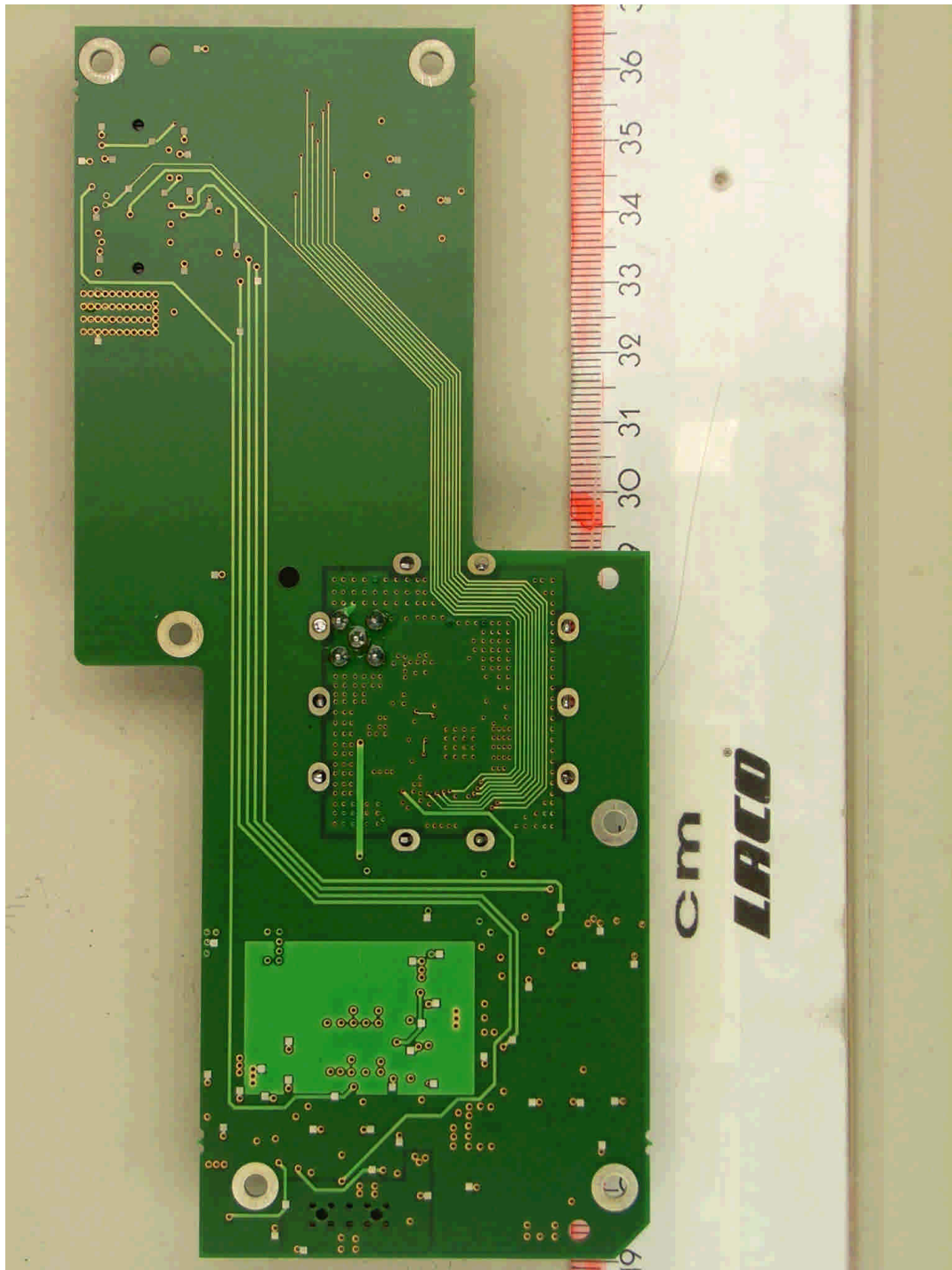
SePem 01 Master, main PCB, top view

Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_m.jpg SePem 01 Master, main PCB, detail view to rf-part, cover removed

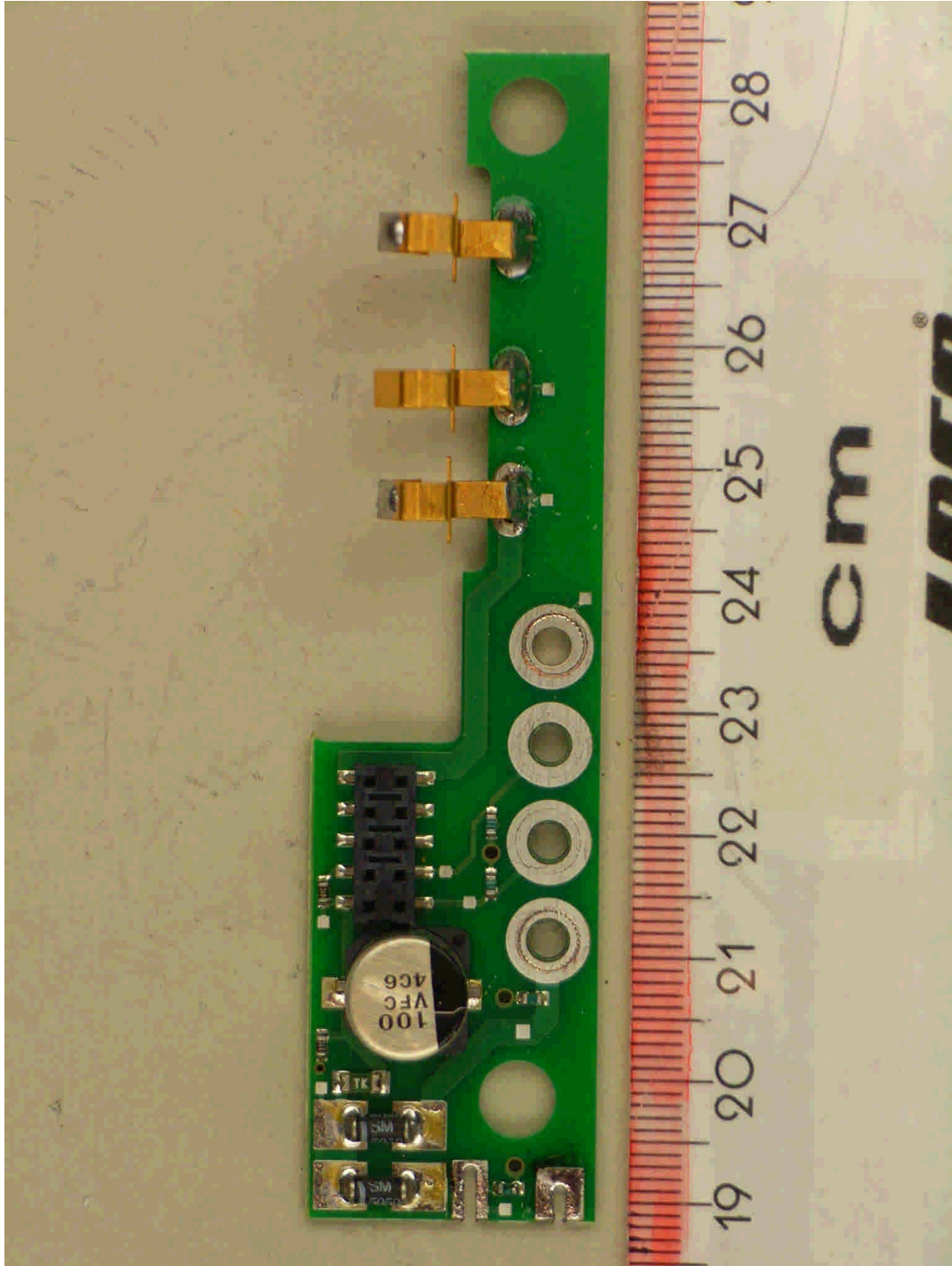
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_o.jpg

SePem 01 Master, main PCB, bottom view

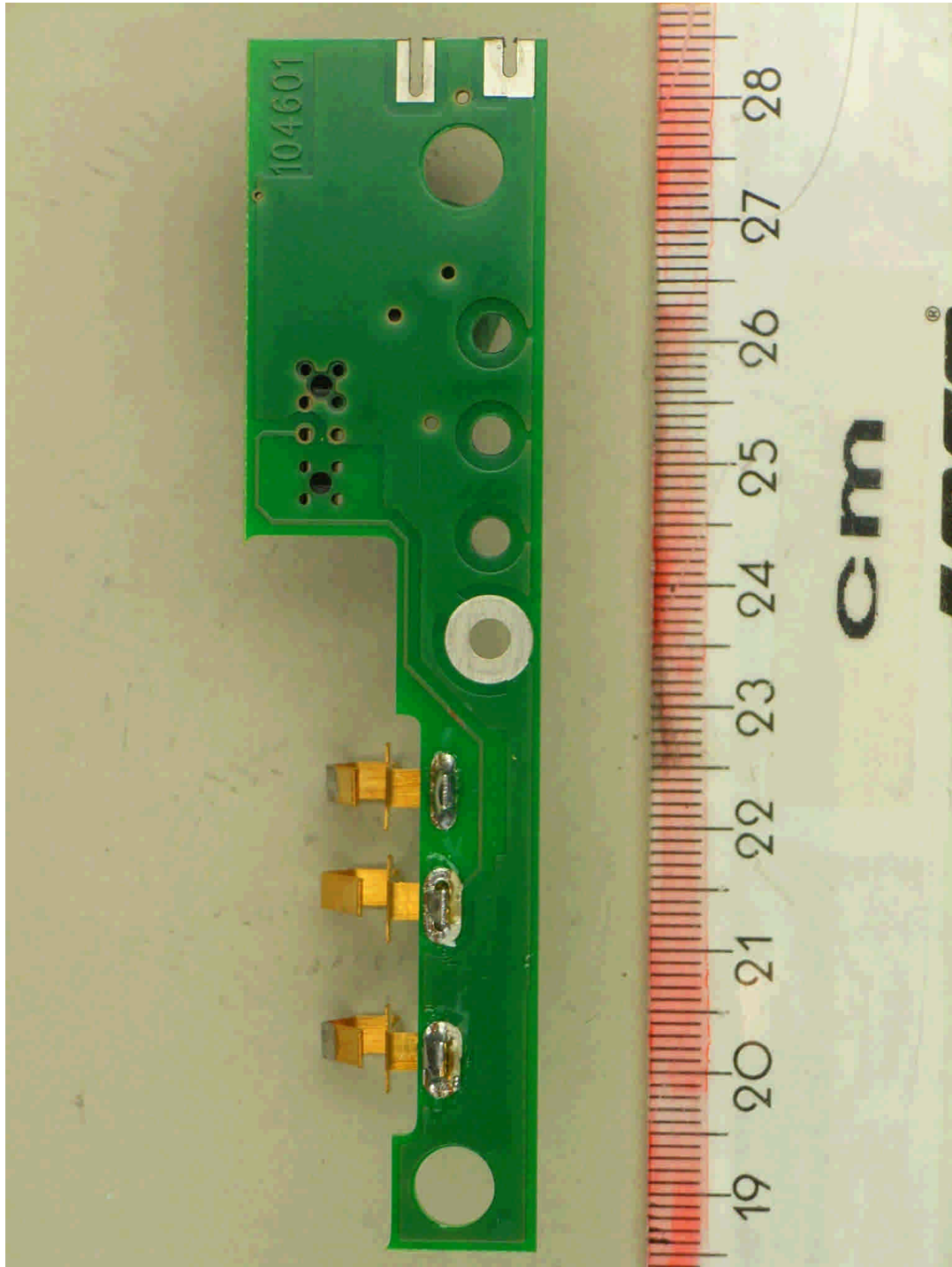
Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_i.jpg

SePem 01 Master, contact PCB, top view

Annex C of test report F060942E02
EUT: SePem 01 Master
Manufacturer: Hermann Sewerin GmbH



60942_l.jpg

SePem 01 Master, contact PCB, bottom view